



Customer Information Notification

201905006I

Issue Date: 22-Jun-2019

Effective Date: 23-Jun-2019

Dear *Emma Tempest*,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to [view this notification online](#)

This notice is NXP Company Proprietary.



Change Category

- | | | | |
|--|--|---|--|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly [] Product Marking Process | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly [] Mechanical Materials Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly [] Location Packing/Shipping/Labeling Equipment | <input type="checkbox"/> Test Equipment | <input checked="" type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | |

S32K1xx General Market Datasheet, Reference Manual Update to Rev10

Description

NXP Semiconductors is announcing an update of Datasheet, Reference Manual for the S32K1xx family. The Datasheet will be updated from revision 9 to revision 10.

The Reference Manual will be updated from revision 9 to revision 10.

A file containing the summary of all changes to these documents is attached with this notification.

The updated documentation is attached to this notice and can be found at:

https://www.nxp.com/products/processors-and-microcontrollers/arm-based-processors-and-mcus/s32-automotive-platform/32-bit-automotive-general-purpose-microcontrollers:S32K?fpsp=1&tab=Documentation_Tab&lang_cd=en

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02 and SEM-DS-03.

Reason

The Datasheet, Reference Manual for S32K1xx family have been updated to provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

A new datasheet will be issued

Additional information

Affected products and sales history information: see attached file

Additional documents: [view online](#)



Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Na Wang
Position Product Engineer
e-mail address na.wang@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

[View Notification](#)

[Subscription](#)

[Support](#)

[NXP](#) | [Privacy Policy](#) | [Terms of Use](#)

NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.